



1N4448HWS

SURFACE MOUNT FAST SWITCHING DIODE

Features

Fast Switching Speed

Ultra-Small Surface Mount Package

For General Purpose Switching Applications

High Conductance

Lead Free/RoHS Compliant (Note 3)

Mechanical Data

Case: SOD-323

Case Material: Molded Plastic. UL Flammability Classification

Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020C Leads: Solderable per MIL-STD-202, Method 208

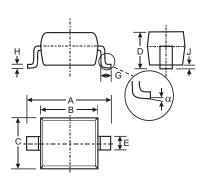
Lead Free Plating (Matte Tin Finish annealed over Alloy 42

leadframe).

Polarity: Cathode Band

Marking: T5

Weight: 0.004 grams (approximate)



SOD-323				
Dim	Min Max			
Α	2.30	2.70		
В	1.60 1.80			
С	1.20 1.40			
D	1.05 Typical			
E	0.25	0.35		
G	0.20 0.40			
Н	0.10 0.15			
J	0.05 Typical			
	0	8		
All Dimensions in mm				

Maximum Ratings @ TA = 25 C unless otherwise specified

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V _{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	80	V
RMS Reverse Voltage	V _{R(RMS)}	57	V
Forward Continuous Current	I _{FM}	500	mA
Average Rectified Output Current	Io	250	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0 s @ t = 1.0s	I _{FSM}	4.0 2.0	А
Power Dissipation (Note 2)	Pd	200	mW
Thermal Resistance Junction to Ambient Air (Note 2)	R _{JA}	625	C/W
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150	С

Electrical Characteristics @ TA = 25 C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V _{BR(R)}	80		V	I _R = 100 A
Forward Voltage	V _{FM}	0.62	0.72 0.855 1.0 1.25	V	I _F = 5.0mA I _F = 10mA I _F = 100mA I _F = 150mA
Peak Reverse Current (Note 1)	I _{RM}		100 50 30 25	nA A A nA	$\label{eq:VR} \begin{array}{l} V_R = 80V \\ V_R = 75V, T_j = 150 C \\ V_R = 25V, T_j = 150 C \\ V_R = 20V \end{array}$
Total Capacitance	C _T		3.5	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}		4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100$

Notes: 1. Short duration test pulse used to minimize self-heating.

2. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

3. No purposefully added lead.



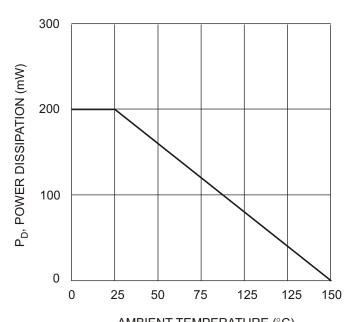
Ordering Information (Note 4)

Device	Packaging	Shipping
1N4448HWS-7-F	SOD-323	3000/Tape & Reel

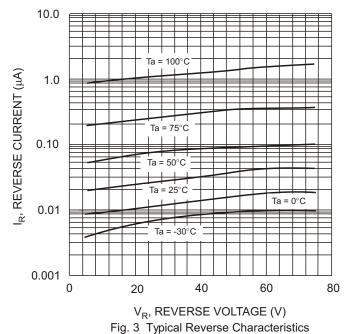
Notes: 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information





AMBIENT TEMPERATURE (°C) Fig. 1 Forward Current Derating Curve



Ta = 25°C

Ta = 50°C

Ta = 0°C

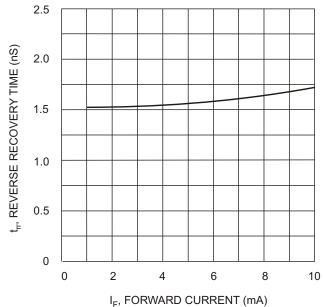
Ta = -30°C

Ta = -30°C

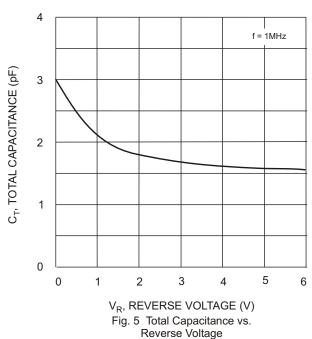
Ta = -30°C

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 $V_{\rm F}$, FORWARD VOLTAGE (mV) Fig. 2 Typical Forward Characteristics







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